Sensitive Gate Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Glassivated PNPN devices designed for high volume consumer applications such as temperature, light, and speed control; process and remote control, and warning systems where reliability of operation is important.

Features

- Glassivated Surface for Reliability and Uniformity
- Power Rated at Economical Prices
- Practical Level Triggering and Holding Characteristics
- Flat, Rugged, Thermopad Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Sensitive Gate Triggering
- These are Pb-Free Devices

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Max	Unit
Peak Repetitive Off–State Voltage (Note 1) (Sine Wave, 50–60 Hz, R_{GK} = 1 kΩ, T_{C} = -40° to 110°C)	V _{DRM,} V _{RRM}		V
C106B C106D, C106D1* C106M, C106M1*		200 400 600	
On-State RMS Current (180° Conduction Angles, T _C = 80°C)	I _{T(RMS)}	4.0	Α
Average On-State Current (180° Conduction Angles, T _C = 80°C)	I _{T(AV)}	2.55	Α
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, T _J = +25°C)	I _{TSM}	20	Α
Circuit Fusing Considerations (t = 8.3 ms)	l ² t	1.65	A ² s
Forward Peak Gate Power (Pulse Width \leq 1.0 μ sec, T _C = 80°C)	P _{GM}	0.5	W
Forward Average Gate Power (Pulse Width ≤1.0 μsec, T _C = 80°C)	P _{G(AV)}	0.1	W
Forward Peak Gate Current (Pulse Width ≤1.0 μsec, T _C = 80°C)	I _{GM}	0.2	Α
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C
Mounting Torque (Note 2)	_	6.0	in. lb.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- Torque rating applies with use of compression washer (B52200F006).
 Mounting torque in excess of 6 in. lb. does not appreciably lower case-to-sink thermal resistance. Anode lead and heatsink contact pad are common.



ON Semiconductor®

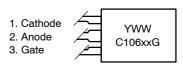
http://onsemi.com

SCRs 4 A RMS, 200 – 600 Volts





MARKING DIAGRAM & PIN ASSIGNMENT



Y = Year

WW = Work Week

C106xx = Device Code

xx = B, D, D1, M, M1

G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	3.0	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	75	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8 in. from Case for 10 Seconds	TL	260	°C

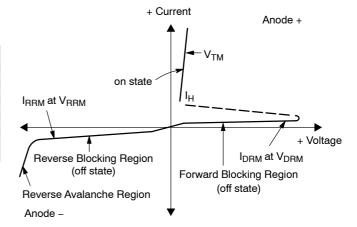
ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted.)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Forward or Reverse Blocking Current (V_{AK} = Rated V_{DRM} or V_{RRM} , R_{GK} = 1 k Ω)	T _J = 25°C T _J = 110°C	I _{DRM} , I _{RRM}	_ _	_ _	10 100	μ Α μ Α
N CHARACTERISTICS						
Peak Forward On-State Voltage (Note 3) (I _{TM} = 4 A)		V _{TM}	_	_	2.2	V
Gate Trigger Current (Continuous dc) (Note 4) $(V_{AK}=6~Vdc,~R_L=100~\Omega)$	$T_J = 25^{\circ}C$ $T_J = -40^{\circ}C$	I _{GT}	- -	15 35	200 500	μΑ
Peak Reverse Gate Voltage ($I_{GR} = 10 \mu A$)		V_{GRM}	-	-	6.0	V
Gate Trigger Voltage (Continuous dc) (Note 4) $(V_{AK}=6~Vdc,~R_L=100~\Omega)$	$T_J = 25^{\circ}C$ $T_J = -40^{\circ}C$	V _{GT}	0.4 0.5	0.60 0.75	0.8 1.0	V
Gate Non-Trigger Voltage (Continuous dc) (Note 4) $(V_{AK} = 12 \text{ V}, R_L = 100 \Omega, T_J = 110^{\circ}\text{C})$		V _{GD}	0.2	_	_	V
Latching Current (V_{AK} = 12 V, I_{G} = 20 mA, R_{GK} = 1 k Ω)	T _J = 25°C T _J = -40°C	ΙL	_ _	0.20 0.35	5.0 7.0	mA
Holding Current (V_D = 12 Vdc) (Initiating Current = 20 mA, R_{GK} = 1 k Ω)	$T_{J} = 25^{\circ}C$ $T_{J} = -40^{\circ}C$ $T_{J} = +110^{\circ}C$	I _H	- - -	0.19 0.33 0.07	3.0 6.0 2.0	mA
DYNAMIC CHARACTERISTICS						
Critical Rate-of-Rise of Off-State Voltage $(V_{AK} = Rated V_{DRM}, Exponential Waveform, R_{GK} = 1 k T_J = 110°C)$:Ω,	dv/dt	_	8.0	_	V/μs

^{3.} Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%. 4. R_{GK} is not included in measurement.

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak On State Voltage
I _H	Holding Current



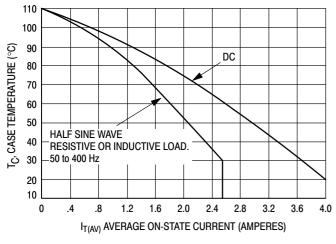


Figure 1. Average Current Derating

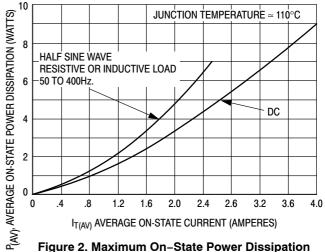


Figure 2. Maximum On-State Power Dissipation

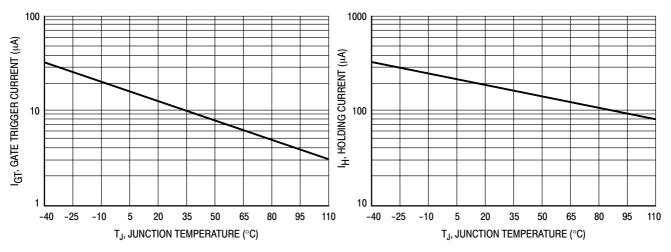


Figure 3. Typical Gate Trigger Current versus Junction Temperature

Figure 4. Typical Holding Current versus Junction Temperature

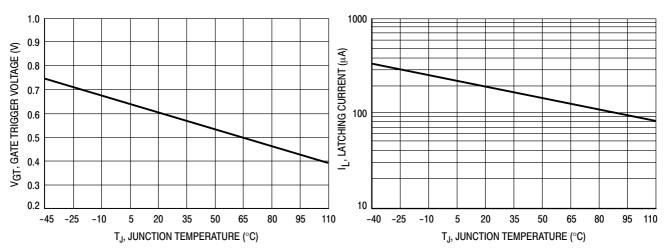
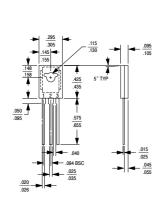


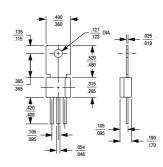
Figure 5. Typical Gate Trigger Voltage versus Junction Temperature

Figure 6. Typical Latching Current versus Junction Temperature

PACKAGE INTERCHANGEABILITY

The dimensional diagrams below compare the critical dimensions of the ON Semiconductor C-106 package with competitive devices. It has been demonstrated that the smaller dimensions of the ON Semiconductor package make it compatible in most lead-mount and chassis-mount applications. The user is advised to compare all critical dimensions for mounting compatibility.





ON Semiconductor C-106 Package

Competitive C-106 Package

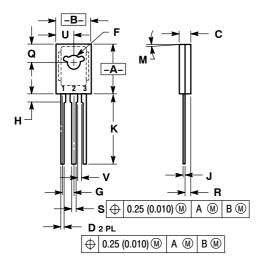
ORDERING INFORMATION

Device	Package	Shipping [†]
C106BG	TO-225AA (Pb-Free)	500 Units / Box
C106DG	TO-225AA (Pb-Free)	500 Units / Box
C106D1G*	TO-225AA (Pb-Free)	500 Units / Box
C106MG	TO-225AA (Pb-Free)	500 Units / Box
C106M1G*	TO-225AA (Pb-Free)	500 Units / Box

 $^{^{\}star}D1$ signifies European equivalent for D suffix and M1 signifies European equivalent for M suffix.

PACKAGE DIMENSIONS

TO-225 CASE 77-09 ISSUE Z



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982
 - CONTROLLING DIMENSION: INCH.
- 3. 077-01 THRU -08 OBSOLETE, NEW STANDARD 077-09.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094 BSC		2.39 BSC	
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.575	0.655	14.61	16.63
M	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
٧	0.040		1.02	

STYLE 2:

PIN 1. CATHODE 2. 3. ANODE

GATE

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TT104N12KOF-K TT162N16KOF-A TT162N16KOF-K TT330N16AOF VS-16RIA100 VS-22RIA20 VS-2N5206 VS-2N685 VS40TPS08A-M3 VS-ST230S12P1VPBF 057219R CLB30I1200HB T1190N16TOF VT T1220N22TOF VT T201N70TOH T830N18TOF
TD92N16KOF-A TT250N12KOF-K VS-2N692 VS-2N689 VS-25RIA40 VS-16RIA120 VS-10RIA120 VS-30TPS08PBF NTE5427
NTE5442 VS-2N690 VS-ST300S20P0PBF TT251N16KOF-K VS-22RIA100 VS-16RIA40 CR02AM-8#F00 TD250N16KOF-A VSST110S16P0 VS-10RIA10 VS-16TTS08-M3 TS110-7A1-AP T930N36TOF VT T2160N24TOF VT T1190N18TOF VT